

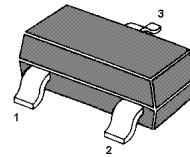
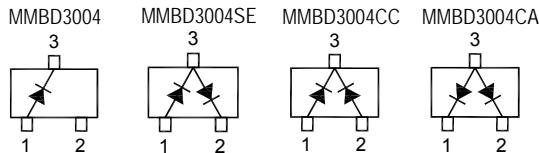
# MMBD3004 / SE / CC / CA

## Silicon Epitaxial Planar Switching Diode

High Voltage Switching Diode

### Features

- Fast switching speed
- High Conductance
- High Reverse Breakdown Voltage Rating



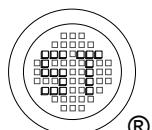
MMBD3004 Marking Code: "HC"  
 MMBD3004SE Marking Code: "PY"  
 MMBD3004CC Marking Code: "PZ"  
 MMBD3004CA Marking Code: "RA"  
 TO-236 Plastic Package

### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	350	V
Working Peak Reverse Voltage	$V_{RWM}$	300	V
DC Blocking Voltage	$V_R$	300	V
Continuous Forward Current	$I_F$	225	mA
Peak Repetitive Forward Current	$I_{FRM}$	625	mA
Non-Repetitive Peak Forward Surge Current at $t = 1 \text{ s}$ at $t = 1 \mu\text{s}$	$I_{FSM}$	1 4	A
Power Dissipation	$P_d$	350	mW
Operating and Storage Temperature Range	$T_j, T_{stg}$	-65 to +150	°C

### Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Min.	Max.	Unit
Forward Voltage at $I_F = 20 \text{ mA}$ at $I_F = 100 \text{ mA}$ at $I_F = 200 \text{ mA}$	$V_F$	- - -	0.87 1 1.25	V
Reverse Current at $V_R = 240 \text{ V}$ at $V_R = 240 \text{ V}, T_j = 150^\circ\text{C}$	$I_R$	- -	100 100	nA μA
Reverse Breakdown Voltage at $I_R = 100 \mu\text{A}$	$V_{(BR)R}$	350	-	V
Total Capacitance at $V_R = 0, f = 1 \text{ MHz}$	$C_T$	-	5	pF
Reverse Recovery Time at $I_F = I_R = 30 \text{ mA}, I_{rr} = 0.1 I_R, R_L = 100 \Omega$	$t_{rr}$	-	50	ns



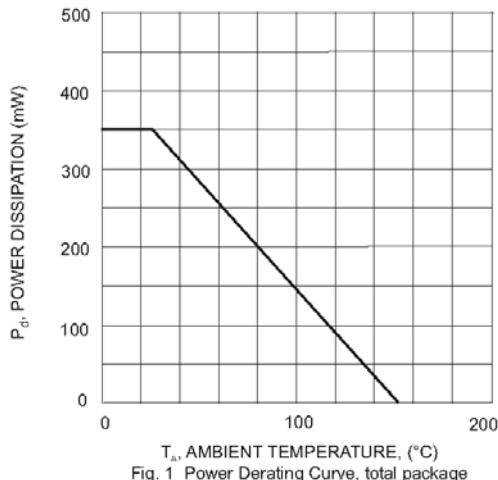


Fig. 1 Power Derating Curve, total package

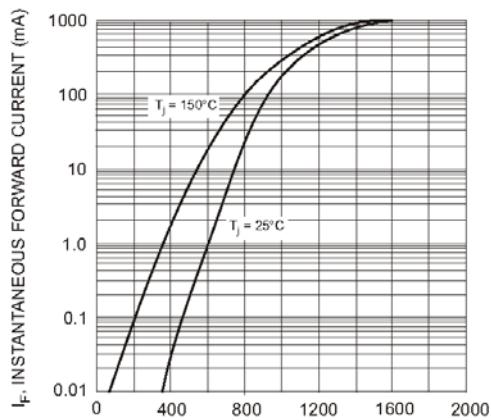


Fig. 2 Typical Forward Characteristics, per element

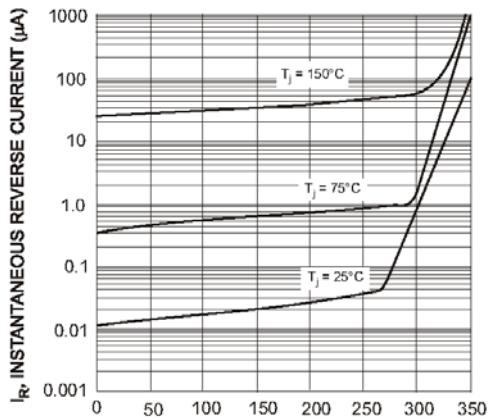


Fig. 3 Typical Reverse Characteristics, per element

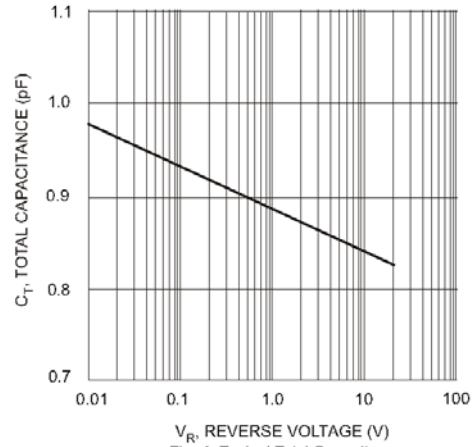


Fig. 4 Typical Total Capacitance vs. Reverse Voltage, per element

